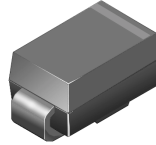


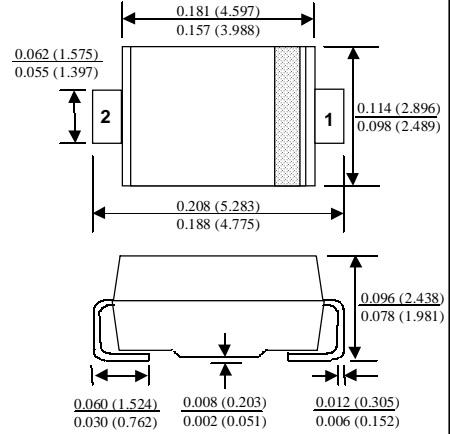
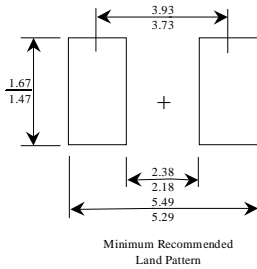
RGF1A - RGF1M

Features

- Glass passivated junction.
- For surface mounted application.
- Low forward voltage drop.
- High current capability.
- Easy pick and place.
- High surge current capability.



SMA/DO-214AC
COLOR BAND DENOTES CATHODE



1.0 Ampere Fast Recovery Rectifiers

Absolute Maximum Ratings*

$T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
I_O	Average Rectified Current @ $T_L = 125^\circ\text{C}$	1.0	A
$I_{f(\text{surge})}$	Peak Forward Surge Current 8.3 ms single half-sine-wave Superimposed on rated load (JEDEC method)	30	A
P_D	Total Device Dissipation Derate above 25°C	1.76 11.7	W mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient **	85	°C/W
$R_{\theta JL}$	Thermal Resistance, Junction to Lead**	28	°C/W
T_{stg}	Storage Temperature Range	-65 to +175	°C
T_J	Operating Junction Temperature	-65 to +175	°C

*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

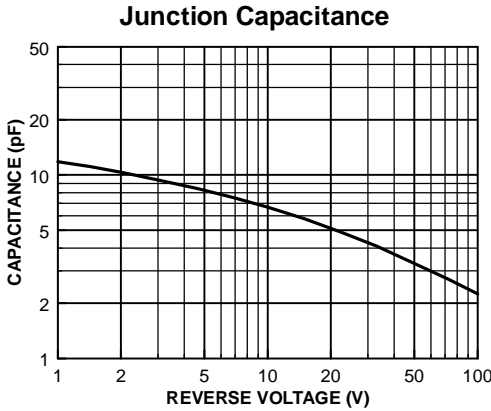
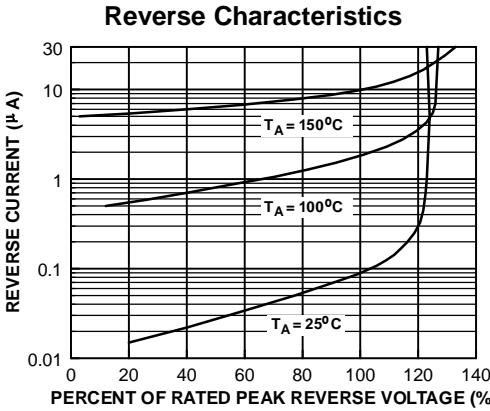
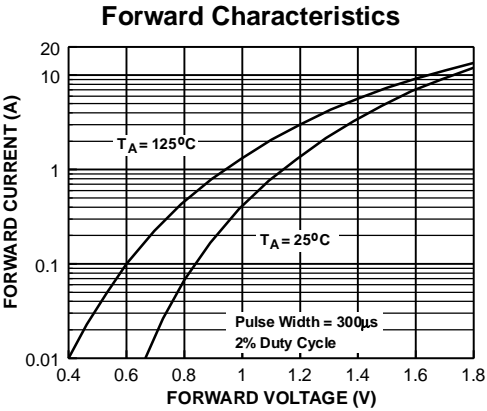
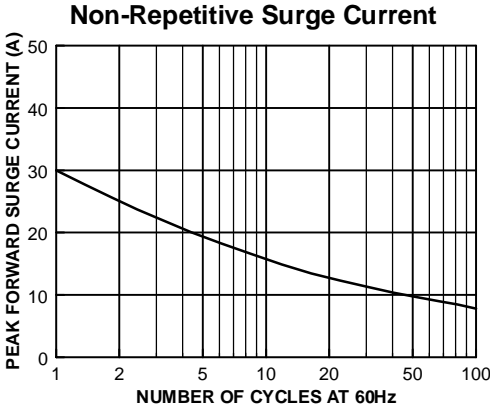
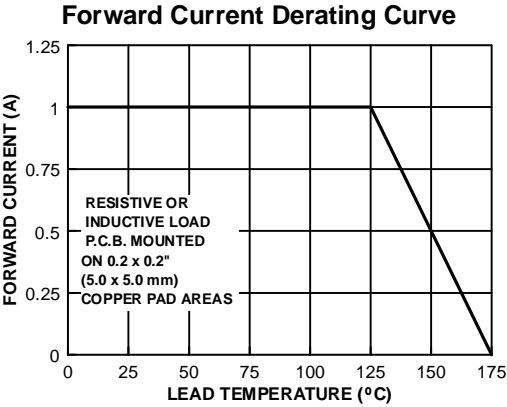
**Device mounted on FR-4 PCB 0.013 mm.

Electrical Characteristics

$T_A = 25^\circ\text{C}$ unless otherwise noted

Parameter	Device							Units
	1A	1B	1D	1G	1J	1K	1M	
Peak Repetitive Reverse Voltage	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	35	70	140	280	420	560	700	V
DC Reverse Voltage (Rated V_R)	50	100	200	400	600	800	1000	V
Maximum Reverse Current @ rated V_R $T_A = 25^\circ\text{C}$ $T_A = 125^\circ\text{C}$	5.0 100							μA μA
Maximum Forward Voltage @ 1.0 A	1.3							V
Maximum Reverse Recovery Time $I_F = 0.5 \text{ A}$, $I_R = 1.0 \text{ A}$, $I_{rr} = 0.25 \text{ A}$	150			250		500		nS
Typical Junction Capacitance $V_R = 4.0 \text{ V}$, $f = 1.0 \text{ MHz}$	8.5							pF

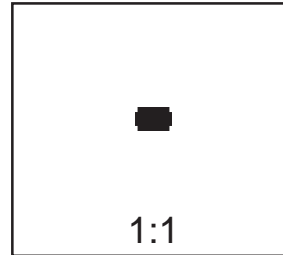
Typical Characteristics



SMA/DO-214AC Package Dimensions



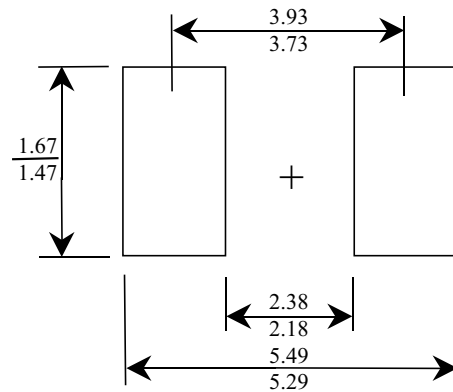
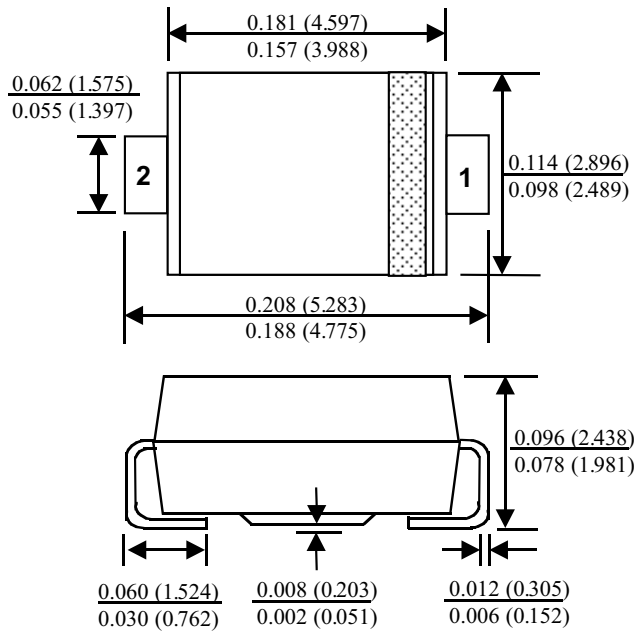
SMA/DO-214AC (FS PKG Code P5)



Scale 1:1 on letter size paper

Dimensions shown below are in:
inches [millimeters]

Part Weight per unit (gram): 0.064



Minimum Recommended
Land Pattern

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E ² CMOS™	PowerTrench®	VCX™
FACT™	QFET™	
FACT Quiet Series™	QS™	
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FASTr™	SuperSOT™-3	
GTO™	SuperSOT™-6	

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No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
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